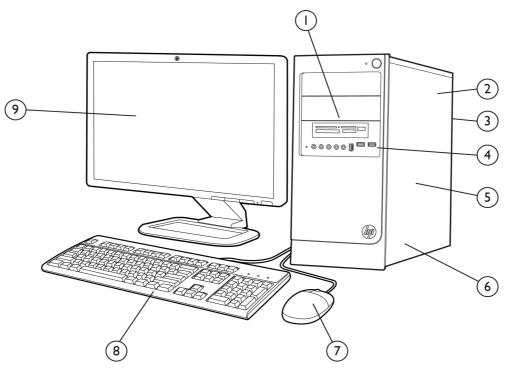
Overview (availability varies by configuration and by country)



- 1. (2) external 5.25" drive bays for optional optical drives
- 2. Power Supply (1) external 3.5" drive bay for optional media reader
- Rear I/O includes: (4) USB 2.0 ports, SPDIF out, RJ-45 3. network interface, DVI-I & DVI-D video interfaces, microphone jack, audio in/out jacks, 7.1 channel audio jacks
- Front I/O includes: (2) USB 3.0 ports, dedicated headphone 9. Monitor (sold separately) 4. output, microphone jack
- 6. (3) PCIe x1 slots, (1) PCIe x16 slot, (1) miniPCIe slot
- **USB** Scroll Mouse 7.
- 8. HP USB Standard Value Keyboard

(2) internal 3.5" hard drive bays 5.

At A Glance

- Genuine Windows 7 versions or FreeDOS
- Choice of Intel® Core™ i3,Core i5, or Core i7 processor
- Choice of integrated graphics or ATI or NVIDIA graphics cards
- Up to 16 GB DDR3 SDRAM system memory available standard
- Up to 2 TB 3.0 Gb/s SATA hard drive
- SuperMulti DVD Drive
- Integrated Realtek 8111E Gigabit Ethernet Controller
- 12 USB ports
- DVI-I & DVI-D video port
- 7.1 audio channels
- Protected by HP Services. Terms and conditions vary by country. Certain restrictions and exclusions apply.



Standard Features (availability varies by configuration and by country)

Processors (Availability depends on model; list is subject to change)	Intel Core i3 Processor	's:				
	Intel Core i3-2100 Processor (3.1 GHz, 3 MB cache, 2C/4T)					
	Intel Core i3-2105 Processor (3.1 GHz, 3 MB cache, 2C/4T)					
	 Intel Core i3-2120 Processor (3.3 GHz, 3 MB cache, 2C/4T) Intel Core i5 Processors: Intel Core i5-2310 Processor (2.8 GHz, 6 MB cache, 4C/4T, Turbo) Up to 3.1 GHz with Intel Turbo Boost Technology Intel Core i5-2400 Processor (3.1 GHz, 6 MB cache, 4C/4T, Turbo) Up to 3.4 GHz with Intel Turbo Boost Technology Intel Core i5-2500 Processor (3.3 GHz, 6 MB cache, 4C/4T, Turbo) Up to 3.7 GHz with Intel Turbo Boost Technology Intel Core i7 Processors: Intel Core i7-2600 Processor (3.4 GHz, 8 MB cache, 4C/8T, Turbo) Up to 3.8 GHz with Intel Turbo Boost Technology Intel Pentium: Intel Pentium G620 Processor (2.6 GHz, 3 MB L3 cache) Intel Pentium G850 Processor (2.9 GHz, 3 MB L3 cache) Intel Pentium G850 Processor (2.9 GHz, 3 MB L3 cache) 					
				NOTE: Intel processor numbers are not a measure of performance. Processor numbers differentiate features within each processor family, not across different processor families.		
Operating System				Preinstalled	Genuine Windows 7 Professional Edition (32-bit)*	
		Genuine Windows 7 Professional Edition (64-bit)*				
		Genuine Windows 7 Home Premium Edition (64-bit)* Genuine Windows 7 Home Basic Edition (64-bit)*				
		Genuine Windows 7 Home Ultimate Edition (64-bit)*				
		FreeDOS				
	* System may require upgraded and/or separately purchased hardware and/or a DVD drive to install the					
	Windows 7 software and take full advantage of Windows 7 functionality. See http://www.microsoft.com/windows/windows-7/ for details.					
	http://www.microsoli.co	Sm/windows/windows-77 for deldils.				
Chipset	Intel H67 Express Chipset					



Standard Features (availability varies by configuration and by country)

G

Graphics			
Integrated	Intel HD Graphics		
Graphics Cards (List is subject to change)	AMD Radeon HD 6450 1GB DDR3 FH PCle x16 Card AMD Radeon HD 6450 512MB DDR3 FH PCle x16 Card AMD Radeon HD 6570 1GB DDR3 FH PCle x16 Card AMD Radeon HD 6570 2GB DDR3 FH PCle x16 Card		
	NVIDIA GeForce GT 420 NVIDIA GeForce GT440 NVIDIA GeForce GT440 3 NVIDIA GeForce GT 520 NVIDIA GeForce GT 530	1.5GB PCle x16 Card	
System Memory	Memory Type Expansion Slots Maximum Memory* Standard Configurations	PC3-10600 DDR3 SDRAM (1066/1333MHz) non-ECC Four (4) DIMM slots 16 GB 2 GB (1 \times 2GB) 3 GB (1 \times 1GB + 1 \times 2GB) 4 GB (1 \times 4GB) 4 GB (2 \times 2GB) 5 GB (2 \times 2GB + 1 \times 1GB) 5 GB (1 \times 4GB + 1 \times 1GB) 6 GB (1 \times 2GB + 1 \times 4GB) 6 GB (3 \times 2GB) 7 GB (3 \times 2GB) 8 GB (4 \times 2GB) 8 GB (2 \times 4GB) 9 GB (2 \times 4GB + 1 \times 1GB)	

16 GB (4 x 4GB) * For systems configured with more than 3 GB of memory and a 32-bit operating system, all memory may not be available due to system resource requirements. Addressing memory above 4 GB requires a 64-bit operating system.

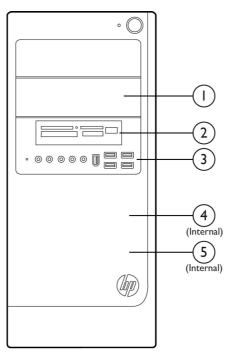
 $10 \text{ GB} (3 \times 2\text{GB} + 1 \times 4\text{GB})$

12 GB (3 x 4GB)



Standard Features (availability varies by configuration and by country)

Storage	Hard Drive (SATA) (up to 2 drives supporte	3.5-inch, 7200 rpm, 3.0 Gb/s SATA Hard Drive (NCQ, SMART): d) 500 GB 1 TB 1.5 TB 3.5-inch, 5400 rpm, 3.0 Gb/s SATA Hard Drive (NCQ, SMART): 1.5 TB 2 TB		
RAID 1 Configuration of Media Reader Optical Drive (SATA) (up to 2 drives supporte	RAID 1 Configuration o	RAID 1 Configuration optional		
	Media Reader	HP 15-in-1 Media Card Reader		
	HP SATA 16X SuperMulti DVD d)			
,	Internal	Two (2) 3.5-inch		
	External	Two (2) 5.25-inch; One (1) 3.5-inch		



	Maximum Quantity Supported	Position Supported	Controller
Drive Support			
Media Reader	1	2	Internal USB 2.0 port
SuperMulti DVD Drives	2	1	SATA
3.5" Serial ATA Hard Drives	2	4,5	SATA



Standard Features	s (availability varies by c	configuration and by country)
Slots	# PCI 2.3 slots# PCI Express x1 slots# PCI Express x16 slots# MiniPCle slots	0 3 1 1
Communication	Integrated Realtek RTL81 Intel Gigabit CT Desktop	11E GbE Ethernet Controller NIC
USB Support	EHCI high-speed USB 2.0 Fourteen (14) internal por 2 for front ports 4 for rear ports 1 for media card re 5 reserved for futur External USB 2.0 ports Front Rear	rts on system board: eader
Interfaces	One (1) DVI-I video port One (1) DVI-D video port One (1) RJ45 network port One (1) SPDIF out One (1) audio in; 5.1/7.1 audio channel out; one (1) microphone in	
Audio	IDT 92HD89E High Definition audio codec	
Input Devices	Keyboard - One of the following HP USB Standard Value Keyboard Mouse - One of the following HP USB Optical BLK Mouse	
Miscellaneous	HP Chassis Security Kit HP Firewire/IEEE1394a P	Clex1 card



Standard Features (availability varies by configuration and by country)

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Software	Preinstalled software (varies by country) Microsoft Office 2010 Starter Preloaded (purchase of a Product Key required to activate a full Office 2010 suite)* Microsoft Windows Virtual PC - XP Norton Internet Security 2011 (60-day trial) PDF Complete Special Edition HP Power Assistant Credential Manager for HP ProtectTools HP ProtectTools Suite SMB USB Port Disable) Xobni HP Recovery Manager HP Support Assistant (HPSA) * Microsoft Office 2010 Starter Preloaded includes reduced functionality versions of Word and Excel, unless a full version suite is added to the configuration at additional cost. Purchase of Product Key			
	required to activate full Office 2010 suite available at participating resellers/retailers and http://www.office.com. ** Supporting software available with certain optical drive configurations.			
Security	Padlock loop			
,	Kensington Lock Support Noble Universal Clamp Lock Cable Kit			
	HP Chassis Security Kit			
Power Supply	300W aPFC power supply			
Model	300W aPFC			
Rated Voltage Range	100 – 240 VAC			
115V/230V Line switch	N/A			
Service and Support	On-site Warranty ^{Note 1} : 1-1-1, limited warranty delivers on-site, next business-day ^{Note 2} service for parts and labor and includes free telephone support ^{Note 3} 24 x 7. Global coverage ^{Note 2} ensures that any product purchased in one country and transferred to another non-restricted country will remain fully covered under the original warranty and service offering. One-year onsite and labor are not available in all countries. NOTE 1: Terms and conditions may vary by country. Certain restrictions and exclusions apply. Other			
	warranty variations may be offered in your region.			
	NOTE 2: On-site service may be provided pursuant to a service contract between HP and an authorized HP third-party provider, and is not available in certain countries. Global service response times are based on commercially reasonable best effort and may vary by country.			
	NOTE 3: Technical telephone support applies only to HP-configured Compaq and third-party HP- qualified hardware and software. Toll-free calling and 24 x 7 support may not be available in some			



After-Market Options (availability varies by configuration and by country)

NOTE: After-Market Options are TBD.



Technical Specifications

System Unit	Dimensions (HxWxD)	14.37 x 6.50 x 14.69in 365 x 165 x 373mm	
	Weight	21.16 lb (9.60 kg)	
	Packaging Dimensions (DxLxW)	10.31 x 20.55 x 19.61 in 262 x 522 x 498mm	
	Shipping Weight	27.56 lb (12.50 kg)	
	Temperature	Operating	32° to 104° F (0° to 40° C)
		Non-operating	-22° to 149° F (-30° to 65° C)
	Relative Humidity	Operating	10% to 90% (non-condensing at ambient)
		Non-operating	5% to 95% (non-condensing at ambient)
	Shock	Operating	40 G, half-sine
		Non-operating	Velocity change (± 5%): 165 cm/sec minimum goal, 127 cm/sec minimum required. Between 2 and 3 milliseconds, half-sine
	Maximum Altitude	Operating	10,000 ft (3048 m)
	(unpressurized)	Non-operating	30,000 ft (9144 m)
	For accessibility information on HP products, please visit: http://www.hp.com/accessibility.		
Unit Environment and Operating Conditions	cold, to ensure tha • Leave a 4 in (10.2 airflow.	away from excessive moistur t unit is operated within the s	sides of the computer to permit the required

- Do not stack computers on top of each other or place computers so near each other that they are subject to each other's re-circulated or preheated air.
- Occasionally clean the air vents on the front, back, and any other vented side of the computer. Lint, dust and other foreign matter can block the vents and limit the airflow.
- If the computer is to be operated within a separate enclosure, intake and exhaust ventilation must be provided on the enclosure, and the same operating guidelines listed above will still apply.



Technical Specifications

	 IT ECO declaration 			
System Configuration	The configuration used for the Energy slim Desktop model is based on a ty		ise Emissions data for the Ultra-	
Energy Consumption	115 VAC	230 VAC	100 VAC	
Normal Operation	55.46 W	56.23 W	55.11 W	
Sleep (Energy Star low power mode)	1.56 W	1.56 W	1.56 W	
Off	0.92 W	0.92 W	0.92 W	
	NOTE:			
	Energy efficiency data listed is for an family . HP computers marked with t Environmental Protection Agency (Ef does not offer ENERGY STAR® com typically configured model.	the ENERGY STAR® Logo are con PA) ENERGY STAR® specifications	npliant with the applicable U.S. s for computers. If a model family	
Heat Dissipation*	115 VAC	230 VAC	100 VAC	
Normal Operation	190 BTU/hr	192 BTU/hr	188 BTU/hr	
Sleep	5 BTU/hr	5 BTU/hr	5 BTU/hr	
Off	3 BTU/hr	3 BTU/hr	3 BTU/hr	
Declared Noise Emission (in accordance with	* Heat dissipation is calculated base one hour. Is		ig the service level is unumed for	
ISO 7779 and ISO 9296	5)			
ISO 7779 and ISO 9296 (Typically Configured)	5) Sound Power (LWAd, bels)		Sound Pressure (LpAm, decibels)	
	Sound Power			
(Typically Configured)	Sound Power (LWAd, bels)		(LpAm, decibels)	
(Typically Configured) Idle Fixed Disk (random writes)	Sound Power (LWAd, bels) 4.11	y with EU Directive 2006/66/EC	(LpAm, decibels) 30.8	
(Typically Configured) Idle Fixed Disk	Sound Power (LWAd, bels) 4.11 4.25		(LpAm, decibels) 30.8	
(Typically Configured) Idle Fixed Disk (random writes)	Sound Power (LWAd, bels) 4.11 4.25 This battery(s) in this product comply	contain: weight	(LpAm, decibels) 30.8	
(Typically Configured) Idle Fixed Disk (random writes)	Sound Power (LWAd, bels) 4.11 4.25 This battery(s) in this product comply Batteries used in the product do not • Mercury greater the 5ppm by	contain: weight	(LpAm, decibels) 30.8	
(Typically Configured) Idle Fixed Disk (random writes) Batteries	Sound Power (LWAd, bels) 4.11 4.25 This battery(s) in this product comply Batteries used in the product do not • Mercury greater the 5ppm by • Cadmium greater than 10pp Battery size: CR2032 (coin cell) Battery type: Lithium • This product is in compliance 2002/95/EC.	contain: weight m by weight with the Restrictions of Hazardou	(LpAm, decibels) 30.8 32.4 s Substances (RoHS) directive -	
(Typically Configured) Idle Fixed Disk (random writes)	Sound Power (LWAd, bels) 4.11 4.25 This battery(s) in this product comply Batteries used in the product do not • Mercury greater the 5ppm by • Cadmium greater than 10pp Battery size: CR2032 (coin cell) Battery type: Lithium • This product is in compliance 2002/95/EC. • This HP product is designed to Directive - 2002/96/EC.	r contain: weight m by weight	(LpAm, decibels) 30.8 32.4 s Substances (RoHS) directive - l and Electronic Equipment (WEE	



HP Elite 7300 Microtower Business PC

Technical Specifications

- This product contains 0% post consumer recycled plastic (by wt.)
- This product is 93.7% recyclable when properly disposed of at end of life.

Packaging Materials

- External:
 - O Corrugated 1.583 g
- Internal:
 - O Polyethylene low density 0.019 g
 - O o EPS (Expanded Polystyrene) 0.104 g
- The Corrugated packaging material is made from 59.5% recycled content.
- The Polyethylene low density packaging material is made from 0% recycled content.
- The EPS (Expanded Polystyrene) packaging material is made from 0% recycled content.

RoHS Compliance Hewlett-Packard is committed to compliance with all applicable environmental laws and regulations, including the European Union Restriction of Hazardous Substances (RoHS) Directive. HP's goal is to exceed compliance obligations by meeting the requirements of the RoHS Directive on a worldwide basis. By July 1, 2006, RoHS substances will be virtually eliminated (virtually = to levels below legal limits) for all HP electronic products subject to the RoHS Directive, except where it is widely recognized that there is no technically feasible alternative (as indicated by an exemption under the EU RoHS Directive).

Material Usage This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at:

http://www.hp.com/hpinfo/globalcitizenship/environment/supplychain/gen_specifications.html):

- Asbestos
- Certain Azo Colorants
- Certain Brominated Flame Retardants may not be used as flame retardants in plastics
- Cadmium
- Chlorinated Hydrocarbons
- Chlorinated Paraffins
- Formaldehyde
- Halogenated Diphenyl Methanes
- Lead carbonates and sulfates
- Lead and Lead compounds
- Mercuric Oxide Batteries
- Ozone Depleting Substances
- Polybrominated Biphenyls (PBBs)
- Polybrominated Biphenyl Ethers (PBBEs)
- Polybrominated Biphenyl Oxides (PBBOs)
- Polychlorinated Biphenyl (PCB)
- Polychlorinated Terphenyls (PCT)
- Polyvinyl Chloride (PVC) except for wires and cables, and certain retail packaging has been voluntarily removed from most applications.
- Radioactive Substances
- Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)
- Nickel finishes must not be used on the external surface designed to be frequently handled or carried by the user.

Packaging

- HP follows these guidelines to decrease the environmental impact of product packaging:
 - Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.
 - Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
 - Design packaging materials for ease of disassembly.



Technical Specifications

End-of-life Management	 Maximize the use of post-consumer recycled content materials in packaging materials. Use readily recyclable packaging materials such as paper and corrugated materials. Reduce size and weight of packages to improve transportation fuel efficiency. Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards. Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic areas.
and Recycling	To recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.
	The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.
Hewlett-Packard	For more information about HP's commitment to the environment:
Corporate Environmental	Global Citizenship Report http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html
mornalion	Eco-label certifications
	http://www.hp.com/hpinfo/globalcitizenship/environment/productdesign/ecolabels.html
	ISO 14001 certificates: http://www.hp.com/hpinfo/globalcitizenship/environment/operations/envmanagement.html
	http://www.hp.com/hpinio/globalcinzenship/environmeni/operations/envirandigeneni.html

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